



Product Change Notification

Change Notification #: 116701 - 00

Change Title: Universal and China Boxed Intel® Core™ processors: i7+8700, i5+8400 and i5+8500, PCN 116701-00, Product Discontinuance, End of Life

Date of Publication: January 14, 2019

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Product Discontinuance Program Support Begins:	January 14, 2019
Last Product Discontinuance Order Date:	September 30, 2019
Orders are Non-Cancelable and Non-Returnable After:	September 30, 2019
Last Product Discontinuance Shipment Date:	December 27, 2019

Description of Change to the Customer:

Due to lack of market demand Intel is announcing the discontinuance of the Universal and China Boxed Intel® Core™ i7+8700, i5+8400 and i5+8500 Processors listed in the Products Affected table below.

Customers should place their Last Time Orders while supplies last with the latest to be by September 30, 2019 if supplies are still available, and delivery of all orders must be taken no later than December 27, 2019.

Customer Impact of Change and Recommended Action:

Products listed in the "Products Affected/Intel Ordering Codes" table should be managed in accordance with the "Key Milestones" listed above. The "Last Product Discontinuance Order Date" is the final day for customers who carry backlog to book the orders Intel has granted as of the "Orders are Non-Cancellable and Non-Returnable After" (NCNR) date. The "Orders are Non-Cancellable and Non-Returnable After" date applies to all remaining backlog and/or orders after the "Last Product Discontinuance Order Date." From date of PCN publication, interim booking and turn back deadlines or separate Letter Agreements will apply vs. the standard Corporate Assurance Process.

Please contact your local Intel Field Sales representative if you have any further questions about this End of Life notice.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	S-Spec	MM#
Boxed Intel® Core™ i7+8700 Processor	BO80684I78700	S R3QS	977399
Boxed Intel® Core™ i7+8700 Processor	BOC80684I78700	S R3QS	977513
Boxed Intel® Core™ i5+8400 Processor	BOC80684I58400	S R3QT	977514
Boxed Intel® Core™ i5+8500 Processor	BOC80684I58500	S R3XE	977515
Boxed Intel® Core™ i5+8400 Processor	BO80684I58400	S R3QT	977518
Boxed Intel® Core™ i5+8500 Processor	BO80684I58500	S R3XE	977519

PCN Revision History:

Date of Revision:

January 14, 2019

Revision Number:

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Reason:

Originally Published PCN



Product Change Notification

116701 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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